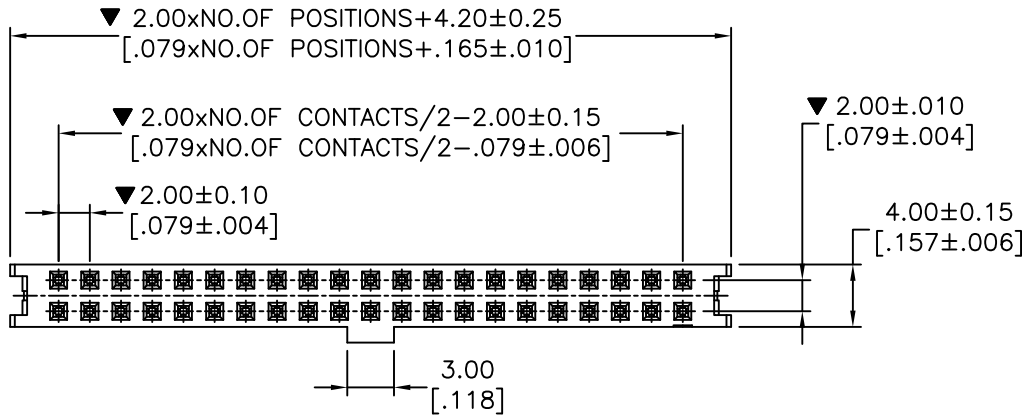
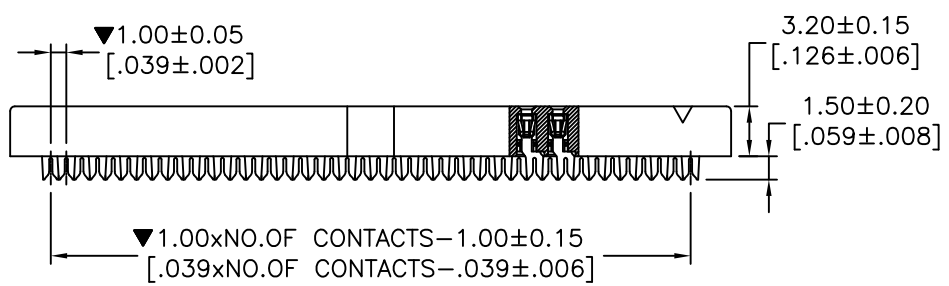
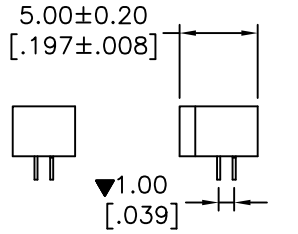
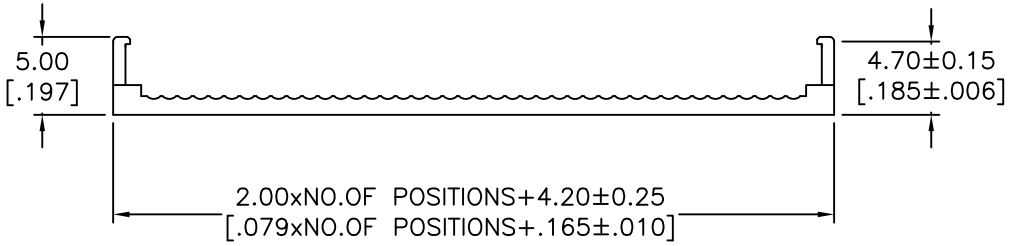
PART NO.	CA-XXMIDL2-A-X-X

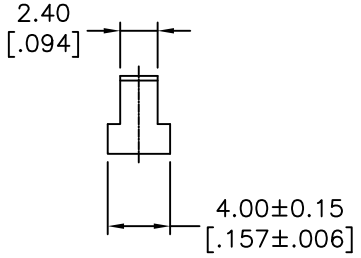
REVISIONS			
LTR	DESCRIPTION	DATE	APPROVED
A	NEW RELEASE SEE DO H5619(Colin)	08/15/13	RAY











ORDERING NOMENCLATURE:

XXMIDL2-A-X-X

POSITION:
6P 8P 10P 12P 14P 16P
20P 22P 24P 26P 30P
34P 36P 40P 44P 50P

CONTACT PLATING:
A=GOLD FLASH PLATED

PLASTIC COLOR:
1=GRAY
2=BLACK

BUMP:
1=WITH BUMP
2=NO BUMP

NOTES:
1.MATERIAL:
HOUSING: PBT+30%GF,UL94V-0
TERMINAL: PHOSPHOR BRONZE
PLATING: Au OR Sn OVER Ni PLATED
2.ELECTRICAL:
CONTACT CURRENT RATING: 1 AMP
WITHSTANDING VOLTAGE: AC 500V AC/DC
INSULATION RESISTANCE:1000 MEGOHMS MIN
CONTACT RESISTANCE:20 MILLIOHMS MAX
OPERATION TEMPERATURE:-40°C TO +105°C
3.MARK" ▼ "DIMENSION MUST CONTROL

4.MEETS THE REQUIREMENTS OF DIRECTIVE 2002/95/EC OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL OF 27 JANUARY 2003 ON THE RESTRICTION OF THE USE OF CERTAIN HAZARDOUS SUBSTANCES IN ELECTRICAL AND ELECTRONIC EQUIPMENT(ROHS).

DIMENSIONS ARE IN MILLIMETERS
TOLERANCES ARE:
DECIMALS ANGLES
.X ± .25 ±3°
.XX ± .13

DIMENSIONS IN BRACKETS [X.XX] ARE IN INCHES TOLERANCES ARE:
DECIMALS ANGLES
.XX ± .010 ±3°
.XXX ± .005

DO NOT SCALE DRAWING

APPROVALS		DATE
DRAWN	Colin	08/15/13
CHECKED	Eric	08/15/13
APPROVED	RAY	08/15/13

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CA CIRCUIT ASSEMBLY SHENZHEN
AO XING ROAD, AOBEI 2ND VILLAGE, HENGGANG TOWN

2.0mm IDC SOCKET "S" TYPE CONNECTOR ASSEMBLY(RoHS)

SIZE	CODE IDENT NO.	DRAWING NO.	REV.
C	52072	H610588	A

SCALE: 1 : 1 SHEET 1 OF 1